

SMC1050S

- Infrared LED
- 1050 nm, 7.5 mW
- Chip: InGaAsP, 300 x 300 μm, 1 pc.
- SMD package, 3.0 x 2.0 x 1.1
- Viewing Angle: 132°

Description

SMC1050S contains one InGaAsP LED chip die mounted on a ceramic SMD package and sealed with silicone or epoxy resin. On forward bias, it emits a radiation power of typical **7.5 mW** at a peak wavelength of **1050 nm**.

Maximum Ratings (T_{CASE}=25°C)

Peromotor	Sympol	Va	Unit	
Parameter	Symbol	Min.	Max.	Unit
Power Dissipation	PD		130	mW
Forward Current	IF		100	mA
Pulse Forward Current *1	I _{FP}		1000	mA
Reverse Voltage	VF		5	V
Thermal Resistance	RTHJA		80	K/W
Junction Temperature	T_J		120	°C
Operating Temperature	T _{CASE}	- 40	+ 85	°C
Storage Temperature	T _{STG}	- 40	+ 100	°C
Lead Solder Temperature *2	T _{SLD}		+ 250	°C

*1 duty=1%, pulse width = 10 μ s

*2 must be completed within 5 seconds

Electro-Optical Characteristics (T_{CASE}=25°C)

Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λ_P	I⊧=50mA	1000		1100	nm
Half Width	$\Delta \lambda$	I⊧=50mA		50		nm
Forward Voltage	VF	I⊧=50mA		1.1	1.3	V
	VFP	P IFP=1A		1.7		v
Reverse Current	I _R	V _R =5V			10	μA
Radiated Power *1	Po	I⊧=50mA		7.5		mW
	FO	IFP=1A		49		
Padiant Intensity *2	IE	I⊧=50mA		2.5		mW/sr
Radiant Intensity *2	IE	IFP=1A		16		11107/51
Viewing Angle	20 1/2	I _F =50mA		132		deg.
Rise Time	t _R	I⊧=50mA		30		ns
Fall Time	t⊨	I _F =50mA		70		ns

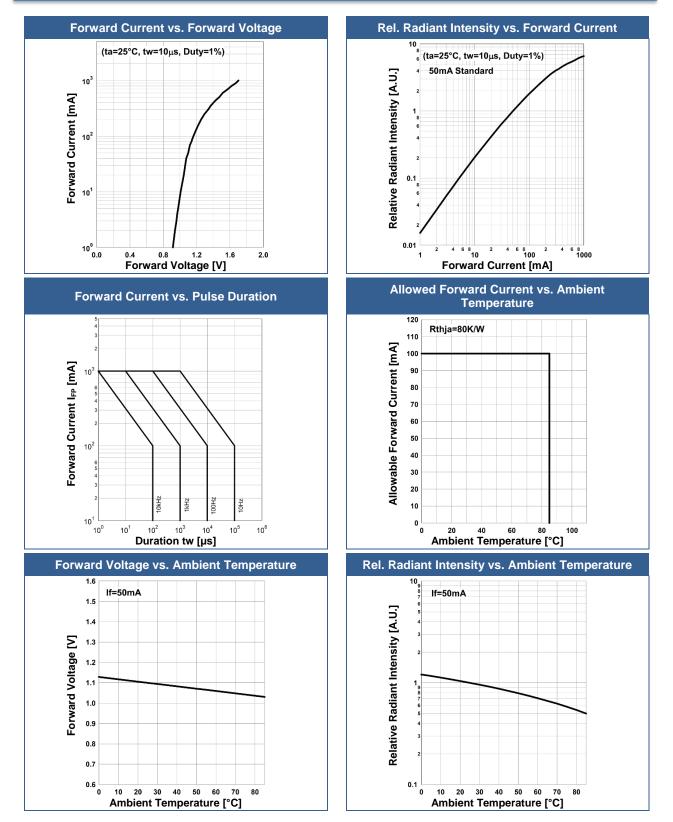
*1 measured by G8370-85

*2 measured by Ando Optical Multi Meter AQ2140 & AQ2742

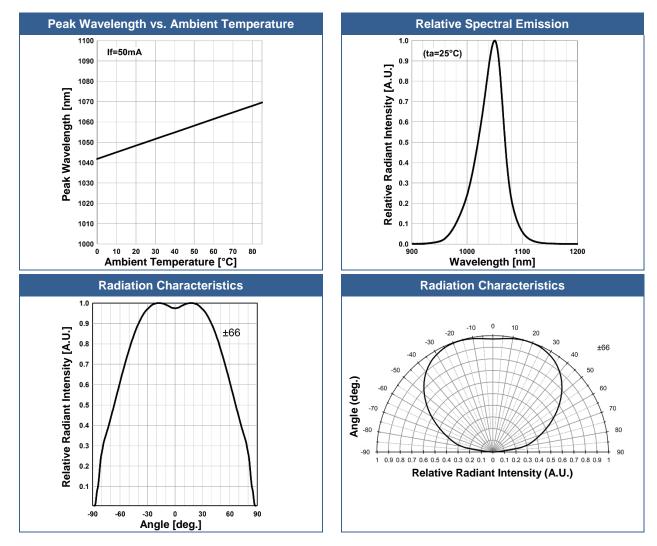




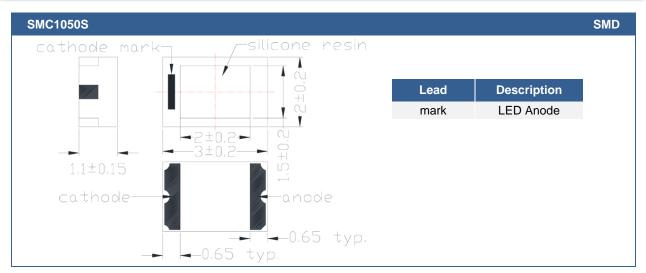
Typical Performance Curves







Outline Dimensions



All Dimensions in mm

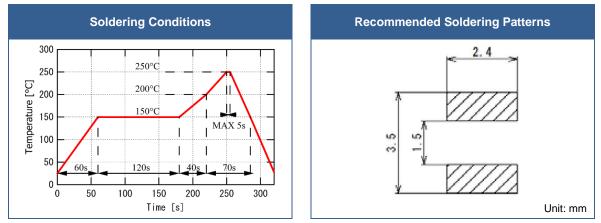


Precautions

Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions:



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. Protective glasses if needed. It is further advised to attach a warning label on products/systems.

Operation:

Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.



Revisions History

Rel.	Rel. Date	Chapter	Modification	Page
A1	2020-03	-	Initial release	-

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The above specifications are for reference purpose only and subjected to change without prior notice